# WT32C3-S1

WT32C3-S2

# Datasheet

2.4GHz WiFi (802.11b/g/n) and Bluetooth 5 module

Built around ESP32-C3 series of SoCs,RISC-V single-core microprocessor

4MB flash

On-board PCB antenna or external antenna connector





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### About this document

This document provides users with the technical specifications for WT32C3-S1 and WT32C3-S2.

### **Document updates**

Please visit Wireless-Tag's official website to download the latest version of the document.

### **Revision history**

Please go to the document revision history page to view the revisions of the document.

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#### Statement

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# **Revision History**

No.	Version	Changes	Change (+/-) Descriptions	Author	Date
1	V1.0.0	С	Created the document	Wang	January 13, 2021

\*Changes: C——create, A——add, M——modify, D——delete

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### 1 Overview

WT32C3-S1 and WT32C3-S2 are general-purpose Wi-Fi and Bluetooth low energy (Bluetooth LE) modules, which are embedded wireless network control modules with low power consumption and high cost performance. It can meet the needs of IoT applications such as smart grid, building automation, security, smart home, and telemedicine.

WT32C3-S1 and WT32C3-S2 modules are equipped with 4 MB external SPI flash. WT32C3-S1 adopts PCB onboard antenna, WT32C3-S2 adopts connector to connect external antenna.

The WT32C3-S1 and WT32C3-S2 modules use the ESP32-C3 chip. The ESP32-C3 chip is equipped with a RISC-V 32-bit single-core processor with a main frequency of up to 160MHz.

The module supports for the standard IEEE802.11 b/g/n protocol and Bluetooth Low Energy 5.0 (Bluetooth LE): Bluetooth 5, Bluetooth mesh. The module can be used to help Bluetooth pairing and network connection to existing devices, or build an independent network controller.



# 2 Features

- SDM-19 package
- On-board PCB antenna
- Operating voltage: 3.3V
- Operating ambient temperature: -20-85°C
- ESP32-C3 chip embedded, 32-bit RISC-V single-core microprocessor, up to 160MHz
  - SRAM 400KB
  - RTC SRAM 8KB
  - ROM 384KB
- Embedded Flash 4MB
- System

WIFI

- IEEE 802.11 b/g/n protocol
- 1T1R mode with data rate up to 150 Mbps
- WIFI @2.4 GHz, support for WEP/WPA-PSK/WPA2-PSK security mode
- Frame aggregation (TX/RX A-MPDU, RX A-MSDU)

BLE

- Bluetooth Low Energy 5.0(Bluetooth LE): Bluetooth 5, Bluetooth mesh
- Speed: 125 Kbps, 500 Kbps, 1 Mbps, 2 Mbps
- Advertising Extensions
- Multiple Advertisement Sets
- Channel Selection Algorithm #2

Hardware

 Support for GPIO, SPI, UART, I2C, I2S, infrared transceiver, LED PWM controller, USB JTAG interface, general DMA controller, TWAITM controller (compatible with ISO11898-1), temperature sensor, SAR ADC

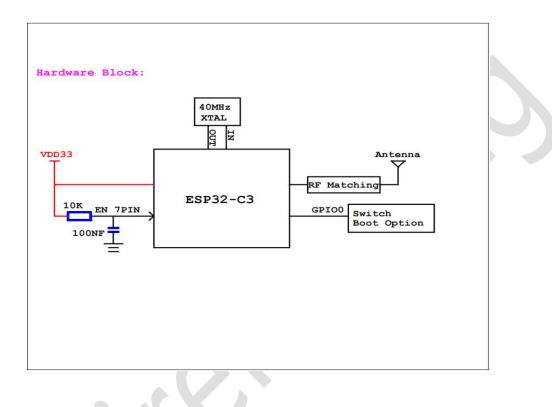
- Support for STA/AP/STA+AP mode
- Support for remote OTA



# **3** Hardware Specifications

## 3.1 Block Diagram

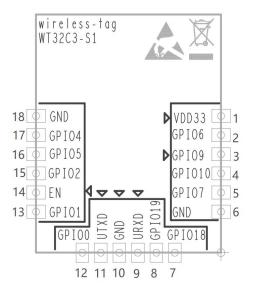
#### Figure 1 Block Diagram





## 3.2 Pin Descriptions

#### Figure 2 Pin Layout



**Table 1 Pin Definitions and Descriptions** 

Pin	Name	Description	
1	VDD33	3.3V power supply; The output current delivered by the external power supply is recommended to be above 500mA.	
2	GPIO6	GPIO6,FSPICLK,MTCK	
3	GPIO9	GPIO9	
4	GPIO10	GPIO10,FSPICS0	
5	GPIO7	GPIO7,FSPID,MTDO	
6	GND	GND	
7	GPIO18	GPIO18,USB_D-	
8	GPIO19	GPIO18,USB_D+	
9	URXD	GPIO20,U0RXD	
10	GND	GND	
11	UTXD	GPIO21,U0TXD	
12	GPIO0	GPIO0.ADC1_CH0,XAL_32K_P	
13	GPIO1	GPIO0.ADC1_CH1,XAL_32K_N	
14	CHIP_EN	Chip Enable pin: High level: on, enables the chip. Low level: off, low current. Note: Do not leave the EN pin floating.	



Pin	Name	Description		
15	GPIO2	GPIO2,ADC1_CH2,FSPIQ		
16	GPIO5	GPIO5,ADC2_CH0,FSPIWP,MTDI		
17	GPIO4	GPIO4,ADC1_CH4,FSPIHD,MTMS		
18	GND	GND		

### 3.3 Strapping Pins

ESP32-C3 series has three strapping pins.

- GPIO2
- GPIO8
- GPIO9

Software can read the strapping values of these pins in "GPIO\_STRAPPING" register.

During the chip's system reset(power-on reset, RTC watchdog reset, brownout reset, analog super watchdog reset, crystal clock glitch detection reset), the latches of the strapping pins sample the voltage level as strapping bits of "0" or "1", and hold these bits until the chip is powered down or shut down.

By default, GPIO9 is connected to the internal pull-up resistor. If GPIO9 is not connected or connected to an external high-impedance circuit, the latched bit value will be "1".

To change the strapping bit values, you can apply the external pull-down/pull-up resistances, or use the host MCU's GPIOs to control the voltage level of these pins when powering on ESP32-C3 family.

After reset, the strapping pins work as normal-function pins.

Refer to Table 2 for a detailed boot-mode configuration of the strapping pins.

Note:

Some pins have been internally pulled up, please refer to the schematic diagram.

#### Table 2 Strapping Pins

Booting Mode <sup>1</sup>						
Pin Default SPI Boot Download Boot						
GPIO2	N/A	1	1			
GPIO8	N/A	Don't care	1			
GPIO9	Internal pull-up	1	0			
Enabling/Disabling ROM Code Print During Booting						

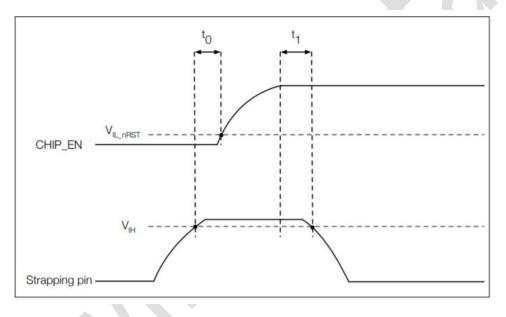
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Pin	Default	Functionality			
		When the value of eFuse field UART_PRINT_CONTROL is			
		0, print is enabled and not controlled by GPIO8.			
GPIO8	N/A	1, if GPIO8 is 0, print is enabled; if GPIO8 is 1, it is disabled.			
		2, if GPIO8 is 0, print is disabled; if GPIO8 is 1, it is enabled.			
		3, print is disabled and not controlled by GPIO8.			
Parameter Descriptions of Setup and Hold Times for the Strapping Pin					
Parameter	Description Min				
t0	Setup time before CHIP_EN goes from low to high		0ms		
t1	Hold time after CHIP_EN goes high		3ms		

Figure 3 shows the setup and hold times for the strapping pin before and after the CHIP\_EN signal goes high.

### Figure 3 Setup and Hold Times for the Strapping Pin



Note:

1. The strapping combination of GPIO8 = 0 and GPIO9 = 0 is invalid.



# **4** Electrical Characteristics

### 4.1 Absolute Maximum Ratings

Stresses above those listed in Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 4.2 Recommended Operating Conditions

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Symbol	Para	neter	Min	Тур	Max	Unit
VDD	Power supply voltage		3.0	3.3	3.6	V
I <sub>VDD</sub>	Current delivered by external power supply		0.5	-	-	А
T <sub>A</sub>	Ambient	85°C version		5.	85	°C
- 11	temperature	105°C version			105	
Humidity	Humidity condition		-	-	85	%RH

#### Table 3 Operating Conditions

# 4.3 Current Consumption

#### Table 4 Current Consumption Depending on RF Modes

Work mode		Description	Peak (mA)
		802.11b, 1 Mbps, @17dBm	384
	TX	802.11g, 54 Mbps, @16.4dBm	287
Active(RF		802.11n, HT20, MCS 7, @16 dBm	275
working)		802.11n, HT40, MCS 7, @16 dBm	260
	DV	802.11b/g/n, HT20	83
	RX	802.11n, HT40	86

Note:

Ambient temperature, 3.3V power supply, TX continues mode, DC power accuracy: 100  $\mu$ A.



Work mode	Description		Typical value
Madam-alaan	The CPU is	160MHz	25.8mA
Modem-sleep	powered on	80MHz	22. 7mA
Light-sleep		0. 3mA	
Deep-sleep		14uA	
Power off	EN	0	

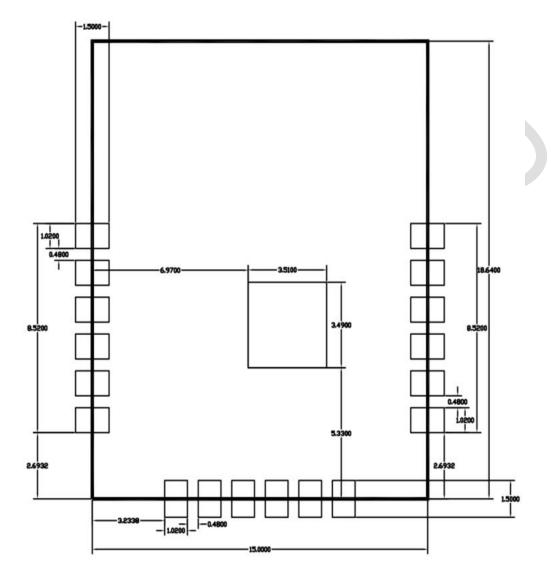
#### Table 5 Current Consumption Depending on Work Modes



# 5 Application Note

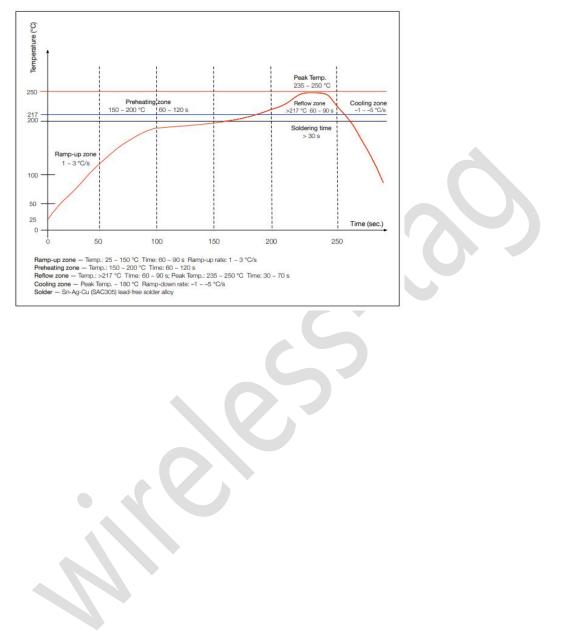
# 5.1 Module Dimensions

#### Figure 4 Module Dimensions





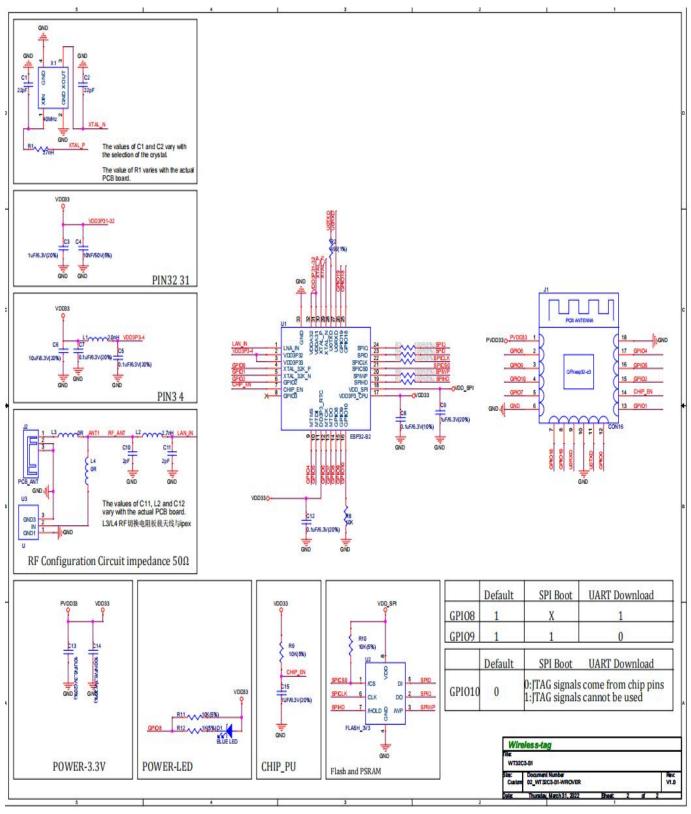
#### Figure 5 Reflow profile





## **5.3 Module Schematics**

#### **Figure 6 Module Schematics**



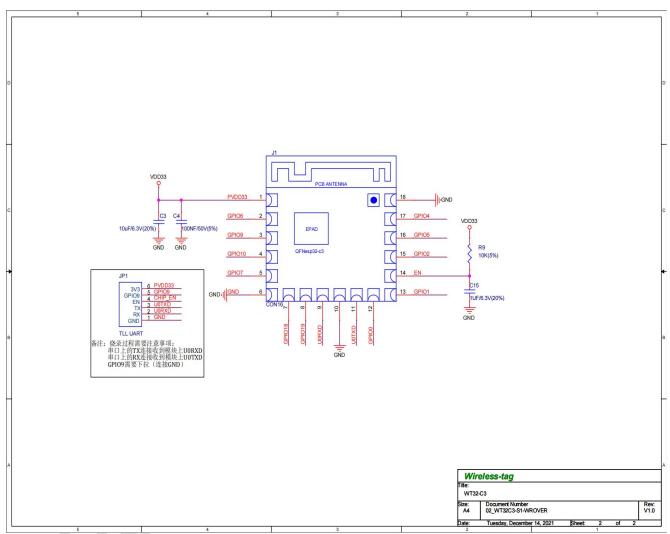


### **5.4 Peripheral Schematic**

This is the typical application circuit of the module connected with peripheral components (for example,

power supply, antenna, reset button, JTAG interface, and UART interface).

#### **Figure 7 Application Circuit**



• Soldering the EPAD to the ground of the base board is not a must, though doing so can get optimized thermal performance. If you do want to solder it, please ensure that you apply the correct amount of soldering paste.

• To ensure the power supply to the ESP32-C3 family chip is stable during power-up, it is advised to add an RC delay circuit at the EN pin. The recommended setting for the RC delay circuit is usually  $R = 10 \text{ k}\Omega$  and  $C = 1 \mu$ F. However, specific parameters should be adjusted based on the power-up timing of the module and the power-up and reset sequence timing of the chip.



# 6 **Product Trial**

- Sales email: sales@wireless-tag.com
- Technical support email: technical@wireless-tag.com